

## 1.6X0.8mm SMD CHIP LED LAMP (0.25mm Height)

Blue

PRELIMINARY SPEC



ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE

**DEVICES** 

Part Number: APG1608PBC/A

### **Features**

- 1.6mmX0.8mm SMT LED, 0.25mm thickness.
- Low power consumption.
- Wide viewing angle.
- Compatible with automatic placement equipment.
- Ideal for backlight and indicator.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

### Description

The Blue source color devices are made with InGaN on SiC Light Emitting Diode.

Static electricity and surge damage the LEDS.

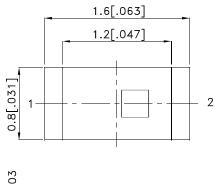
It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

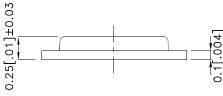
## **Applications**

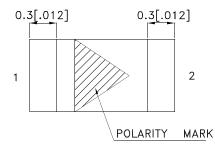
- 1. Mobile phone Keypad indicator and backlight.
- 2.Flat backlight for LCD, switch and symbol.
- 3.Toys.

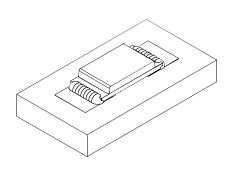
## **Package Dimensions**











### Notes

- All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.1(0.004") unless otherwise noted.
- 3. Specifications are subject to change without notice.
- 4. The device has a single mounting surface. The device must be mounted according to the specifications.





 SPEC NO: DSAI3324
 REV NO: V.2
 DATE: MAR/30/2009
 PAGE: 1 OF 5

 APPROVED: WYNEC
 CHECKED: Allen Liu
 DRAWN: X.M.He
 ERP: 1203007831

## **Selection Guide**

Part No.	Dice	Dice Lens Type Iv (mcd) [2] @ 20mA			Viewing Angle [1]
			Min.	Тур.	201/2
APG1608PBC/A	Blue (InGaN)	WATER CLEAR	18	35	120°

- Notes: 1.  $\theta$ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value. 2. Luminous intensity/ luminous Flux: +/-15%.

## Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Blue	468		nm	IF=20mA
λD [1]	Dominant Wavelength	Blue	470		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Blue	21		nm	IF=20mA
С	Capacitance	Blue	100		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Blue	3.2	4	V	IF=20mA
lR	Reverse Current	Blue		10	uA	V <sub>R</sub> =5V

## Notes:

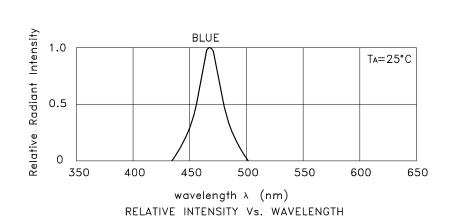
1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

## Absolute Maximum Ratings at TA=25°C

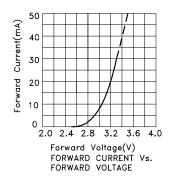
Parameter	Blue	Units	
Power dissipation	120	mW	
DC Forward Current	30	mA	
Peak Forward Current [1]	100	mA	
Reverse Voltage	5	V	
Operating Temperature	-40°C To +85°C		
Storage Temperature	-40°C To +85°C		

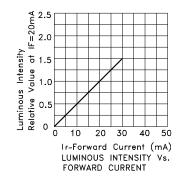
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

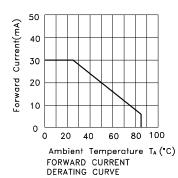
SPEC NO: DSAI3324 **REV NO: V.2** DATE: MAR/30/2009 PAGE: 2 OF 5 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: X.M.He ERP: 1203007831

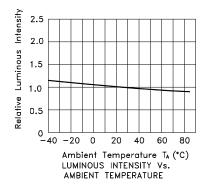


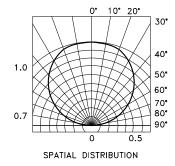
Blue APG1608PBC/A











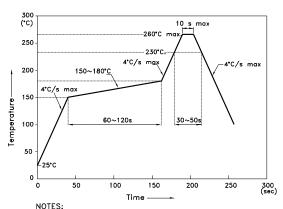
 SPEC NO: DSAl3324
 REV NO: V.2
 DATE: MAR/30/2009
 PAGE: 3 OF 5

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### APG1608PBC/A

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



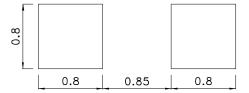
- NOTES:

  1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

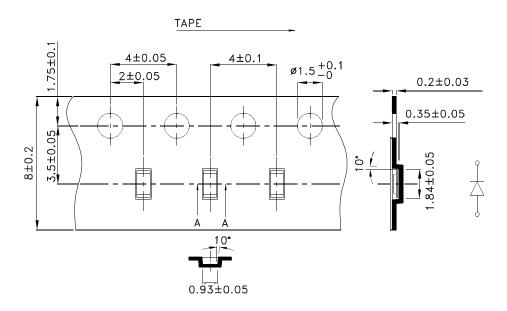
  2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

  3.Number of reflow process shall be 2 times or less.

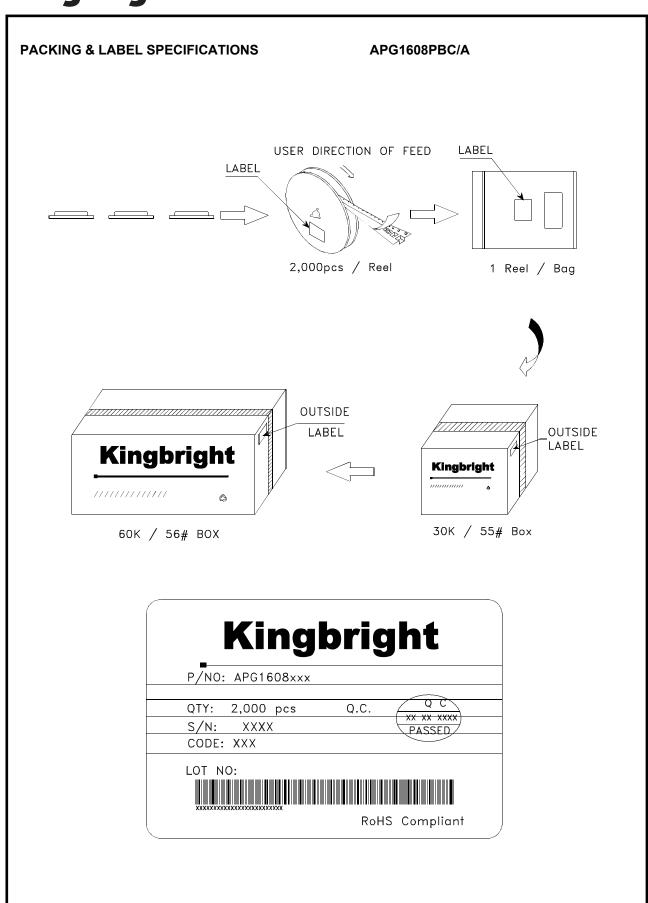
**Recommended Soldering Pattern** (Units: mm; Tolerance: ± 0.1)



**Tape Dimensions** (Units : mm)



SPEC NO: DSAI3324 **REV NO: V.2** DATE: MAR/30/2009 PAGE: 4 OF 5 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: X.M.He ERP: 1203007831



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